Optical Performance of LED using Carbon Doped AIN thin Film as Thermal Interface Material on Metal Substrate

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ABSTRACT

Carbon doped Aluminium Nitride (C-AIN) thin film was synthesized on Al and Cu substrates using RF sputtering and used as heat sink for high power LED. The optical properties of LED such as correlated color temperature (CCT) and brightness (LUX) was recorded by spectrometer and tested for various driving currents. Increased lux level was observed for high driving currents and showed the performance C-AIN thin film as good thermal interface material at high driving currents. The observed CCT values were in between 6180-6900 K and increased for high driving currents. At the lower driving current, CCT value was high for C-AIN on Cu than on Al.overall, the observed optical properties of LED using C-AIN thin film as effective thin film thermal interface material for thermal management in solid state lighting applications.

Key words: Interface material, thermal management and junction temperature.

INTRODUCTION

Light emitting diodes (LEDs) is the device that has higher competition in the industry and one of the promising devices. It is an alternative lighting that reduces the energy consumption and maintenance cost for commercial and residential installations¹⁻³. However, the overheating of this device due to higher input current cause major problem. Thermal management is an important part in the production of LEDs which has significant impact on the lifetime and performance of LEDs. Excess heat during the operation directly influences both short term and long term performance of LEDs. The short-term effects are color shift while the long-term effect is accelerated lumen depreciation and thus shortened useful life. In terms of thermal characteristic of LED, junction temperature is an important parameter which is to determine the heat dissipation efficiency fromp-n junction^{4,5}. Higher the junction temperature causes shorter life-span⁶. This junction temperature can be determined by the thermal transient method⁷.

This paper reported on optical performance of a LEDs with C-AIN as thermal interface material as a function of input current at atmospheric pressure. The CCT and lux values are captured to investigate the optical performance of the LEDs.

EXPERIMENTAL

C-AIN thin films were deposited on metal substrates (Cu and AI) by RF magnetron cosputtering using a C target with 99.9% purity and AI target with 99.9% purity. The Cu and AI substrates were cleaned by rinsing in ultrasonic bath of acetone and then loaded in the central region of the substrate holder. The sputtering chamber was initially evacuated to the base pressure of about 5.5 x 10⁻⁵ mbar, and the vacuum pressure was maintained as 6.17 x 10⁻³ mbar with gas ratio of Ar:N₂=18:2 for all film deposition. Prior to the film deposition, presputtering was carried out for 5 min to remove any other contaminants on the surface of the material source target. For doping C to AIN, AIN thin film was deposited at power 150 W followed by C thin films which was deposited at power 100 W. C-AIN films were grown at room temperature with C using RF power of 100W and AI using DC power of 150W.

The optical performance of LEDs was captured by an MK350 LED meter (Make: UPRtek) spectrometer in determined CCT, luminosity of light and peak wavelength in still air box. The experiment was carried out using a Thermal Transient Tester (T3Ster) at various driving current 150 mA, 250 mA, 350 mA, 450 mA and 550 mA in a still air box at room temperature. C-AIN was used as interface material on metal substrates with LED which is forward biased at 600s and the data was captured in heating time was captured 2 min interval.

RESULTS AND DISCUSSION

The LEDs is mounted on the two different metal substrates that are coated with C-AIN and AIN. Table 1 shows a comparison of Junction temperature (T₂)of C-AIN on AI and Cu substrates and AIN on AI and Cu from table 1. It is clearly shows that the junction temperature increases with respect to driving current. It is also observed that the change in T₂ values of C-AIN on metal substrates is comparatively high at higher driving current 550 mA (Δ T₂ = 4.47°C). From the table 1 also shows AI substrate has high T₂ value than Cu substrates.

This is may be due to Cu (401W/m.K) has high thermal conductivity than AI (205W/m.K). It is also noticed that the AIN thin films does not shows good thermal spreader than C-AIN thin films since the junction temperature AIN thin films on AI substrate as much as high 89.86°C at high driving current (550 mA).

In order to understand the optical behavior of the given LED, the optical properties such as Correlated color temperature (CCT), luminosity and peak wavelength were recorded and the observed result are shown in fig. 1-2. CCT is a measure of light source color appearance. It is also describing color tone in a specification of white light sources along the dimension from warm to cool. The recorded CCT values of the 3W cool white LED at various driving currents for C-AIN on Cu and AI substrate boundary condition are plotted against the LED heating time duration as shown in Fig. 1(a)-(e).

As can be seen from the Fig. 1, CCT values are changing with respect to driving current of the LED along with the interface material applied on various substrates.

The observed values are in between 6180-6900 K. It also reveals that some value of C-AIN on AI started to overlap on C-AIN on Cu when reach 250mA of driving current and totally high at 550mA. Furthermore, the CCT value decreases with respect to heating time.Luminosity is an important optical property since it decides the application of LED lights. Luminosity is measured in terms of LUX (lumens/watt) and describes the effective light output for given driving current. To analyze the influence of C-AIN on changing the luminosity of the given LED, the LUX values of cool white 3W LED was recorded for various driving currents and the observed data are plotted against the burning time as shown in fig. 2(a-e).

From Fig. 2, it indicates that C-AIN on Cu has lower luminosity than C-AIN on AI substrate. However, at the higher driving current, the LUX value

	Junction Temperature ($T_{J}(^{\circ}C)$)			
Driving current (mA)	C-AIN on AI	AIN on AI	C-AIN on Cu	AIN on Cu
150	18.70	19.19	16.15	17.28
250	32.61	33.87	29.87	30.71
350	47.39	49.70	42.94	45.56
450	64.05	70.09	59.28	62.08

Table 1: Junction temperature of C-AIN on metal substrate

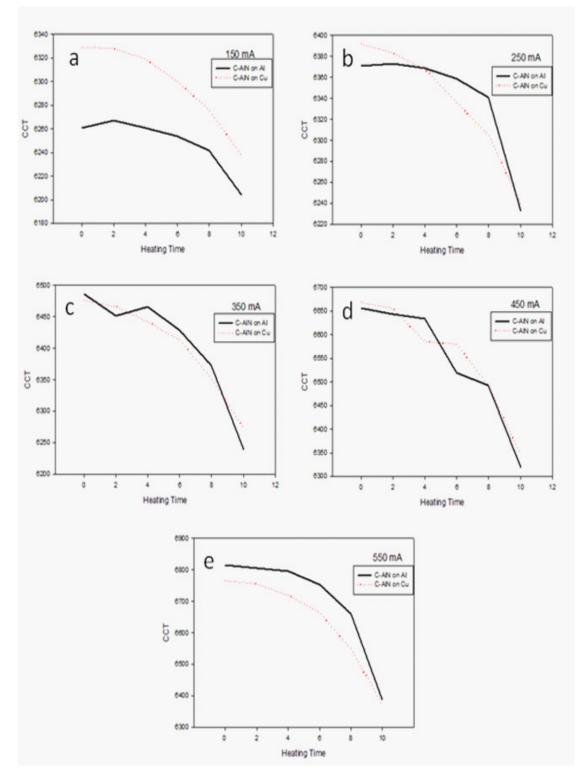


Fig. 1: CCT of the 3W White LED for different substrates at a) 150 mA, b) 250 mA, c) 350 mA, d) 450 mA, and e) 550 mA

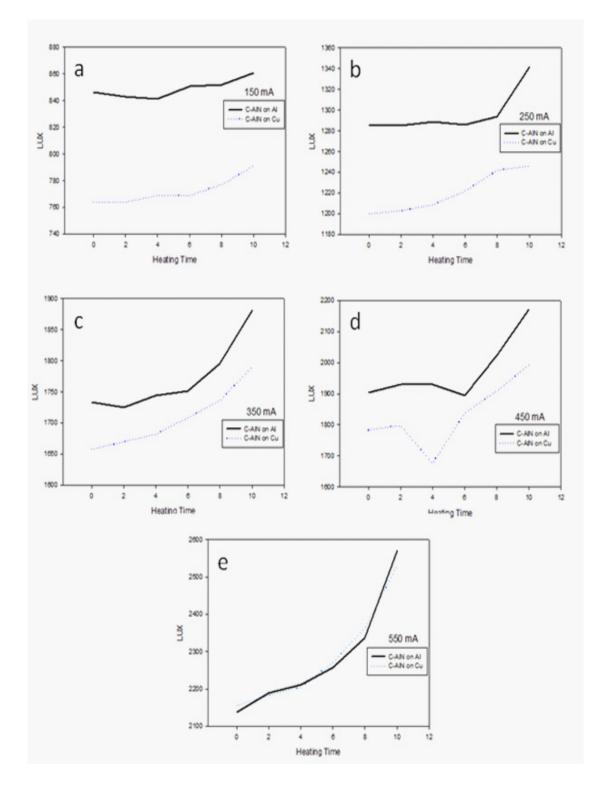


Fig. 2: Brightness of 3W White LED for different substrates at a) 150 mA, b) 250 mA, c) 350 mA, d) 450 mA, and e) 550 mA

of LED fixed on C-AIN/Cu shows overlapped on that of LED fixed C-AIN/AI. From the figure, it clearly shows that both interface material shows increasing luminosity with respect to increase in driving current. Nevertheless, the lux level decreases as the heating time increased.

The observed peak wavelength (λ_{peak}) was varied from 449 nm to 450 nm for all boundary conditions irrespective to the driving currents. The λ_{peak} value is not significant for high power LED.From this observation the observed peak wavelength is red shifted for C-AIN on AI and Cu substrate.Moreover,

shifting peak wavelength is attributed from junction temperature means wavelength is proportional to junction temperature⁸.

CONCLUSION

In this paper, the CCT and lux values were obtained by capturing the result using spectrometer for optical analysis. From the CCT and lux graph the observed value of CCT was in between 6180-6900 K for various driving currents from 150 mA to 550 mA. From this research, an increase in driving current will cause an increase in the luminosity of light.

REFERENCES

- Anithambigai, P., Dinash, K., Mutharasu, D., Shanmugan, S., Lim, C. K. *Thermochimica Acta*, **523**(1-2): 237-244, (2011)
- Steve., Reduce power consumption in your home by installing LED lighting. Slideshare. Retrieved fromhttp://www.slideshare. net/ Stevepearson 45/reduce-the-powerconsumption-in-your-home-by-installing-ledlighting (2013).
- Weng, C. J. Int.Com. in Heat and Mass Transfer. 36(3): 245-248(2009).
- 4. Package Related Thermal Resistance of LEDs. Osram opto Semiconductor. Retrieved from catalog. osramos.com/catalogue/ catalogue. do? act=downloadFile (2014).
- 5. Thermal Design Considerations., Philips

Semiconductor. Retrieved from. www. nxp. com/documents/thermal_design/IC26_ CHAPTER_6.pdf (2000)

- Robert, L.., Lifetime of White LEDs. U.S Department of Energy. Retrievedfromapps1. eere.energy.gov/buildings/publications/.../ lifetime_white_leds.pdf (2009).
- Chin, P. C., Mutharasu, D., Liew, W. C., Thermal characterization of a highpower infrared emitter as a function of input current, *IEEE*, Kota Kinabalu, 1-5 (2011).
- Hong, E. and Narendran, N., A method ffor projecting useful life of LED lighting systems. Retrieved fromhttp://www.streetlighting research.net/programs/solidstate/pdf/ projectingusefullife.pdf (2004).